

SOLID STATE RELAY (I/O Module) MAXIMUM LOAD CURRENT 1 A SN SERIES RoHS compliant

FEATURES

- I/O modules for interface between CPU and external input devices or loads
- Ultra slim and light weight, SIL terminals type I/O modules for high density mounting
 - —Size: 5 (W) \times 20 (L) \times 17 (H) mm
 - -Weight: approximately 3.0 to 3.5 g
- High isolation by employing photo-coupled devices (between input and output: 2,500 V rms)
- · Long life and maintenance free
- All solid state I/O module
- Compatible with NY relay size and terminals arrangement (only output module type)
- RoHS compliant since date code: 6703 (except 204-207) Please see page 9 for more information



ORDERING INFORMATION

Input module

SN - A 100 BF

	011	, ,	וט טו
[Example]	(a)	(b)	(c)

(a)	Series Name	SN : SN Series
(b)	Input Voltage	A: AC type D: DC type
(c)	Nominal Voltage	100 BF: 100 VAC 200 BF: 200 VAC 12/24 B: 12/24 VDC

Output module

 $\frac{\text{SN}}{\text{(a)}} \quad -\frac{12}{\text{(b)}} \quad \frac{\text{D}}{\text{(c)}} \quad \frac{01}{\text{(d)}} \quad \frac{\text{HZ}}{\text{(e)}} \quad -\frac{\text{C}}{\text{(f)}} \quad \frac{\text{R}}{\text{(h)}} \quad \frac{\text{T}}{\text{(h)}}$

(a)	Series Name	SN : SN Series	
(b)	Nominal Voltage (Input side)	3: 3 VDC (only AC type) 5: 5 VDC 12: 12 VDC 24: 24 VDC	
(c)	Load Voltage	A: AC type D: DC type	
(d)	Load Current	01 : 1 A	
(e)	Kinds of Inverse Connection Protecting Element	AC type Nil : with varistor NV: without varistor DC type Nil : Diode HZ: Zener diode	
(f)	Zero Cross function (AC type)	F : without zero cross function C : with zero cross function	
(g)	Output Polarity (DC type)	Nil : Standard polarity R : Reverse polarity	
(h)	Switching Speed (DC type)	Nil : Standard T : High speed type	

■ SPECIFICATIONS

• INPUT MODULE (SN-() B Type)

Item		AC Input Module		DC Input module		
		100 VAC type	200 VAC type	12/24 VDC type		
INPUT side	Input voltage range	80 to 132 160to 265 Vrms Vrms		9.6 to 28.8 VDC		
	Rating input current	Approximate	Approximately 7 mArms		Approx. 10 mA at 24 VDC	
	Power frequency range	47 to 63 Hz		-	-	
	Must operate voltage (max.)	80 Vrms	160 Vrms	9.6 VDC		
	Must release voltage (max.)	30 Vrms	60 Vrms	5.0 VDC		
	Must release current (max.)	2 mArms 1.5 mA		1.5 mA	mA	
OUTPUT	DC supply voltage (VDD)	4 to 6 VDC				
side	Max. output current (VDD=5V)	5V) ±4 mA		±0.4 mA		
	Output logic	Operate with negative true logic (active flow)				
Maximum	operate time (max.)	25 ms		10ms		
Maximum	release time (max.)	30 ms		10ms		
Insulation resistance (initial value)		Minimum 1,000 MΩ (at 500VDC) (for input-output)				
Dielectric strength		2,500 Vrms 1 minute (for input-output)				
Operating temperature range (no frost)		-30°C to +85°C				
Storage temperature range (no frost)		-40°C to +100°C				
Case color		Yellow		White		
Weight		Approximately 2.0 g		Approximately 3.3 g		

• OUTPUT MODULE Standard Type

ltem Remarks		AC Out with zero cross	put module without zero cross	DC Output module		
INPUT side	Nominal Voltage (DC)		3 V, 5 V, 12 V, 24 V		5 V, 12 V, 24 V	
side	Operate Voltage	Range	±20% of n	ominal voltage		
	Must Operate V	oltage	max.80%	of nominal volta	ige	
	Must Release V	oltage	Minimum	Minimum 1 VDC (minimum 0.5 V*)		*3 VDC type
		3 VDC Type	130 Ω	180 Ω	_	
	1 (1	5 VDC Type	330 Ω	470 Ω	390 Ω	
	Input Impedance (±10%)	12 VDC Type	1,0k Ω	1,5k Ω	1,2k Ω	
		24 VDC Type	2,2k Ω	3,0k Ω	2.4k Ω	
OUTPUT	Load Voltage Ra	ange	24 to 265 Vrms		3 to 30 VDC	
side	Maximum Load Current		1.0 Arms		1.0 A	see CHARACTERISTIC DATA
	Minimum Load Current		10 mArms		1 mA	
	Switching Current		50 A (60 Hz)		3 A (10 ms)	
Max. Off-State	x. Off-State Leakage Current			at 100 Vrms 60 Hz) at 200 Vrms 60 Hz)		
	Max. On-State \	/oltage Drop	1.2 Vrms		1.2 V	at max. load current
Maximum Op	perate Time (max.)	1 ms	1/2 cycle ±1 ms	1 ms	
Maximum Re	Maximum Release Time		1/2 cycle + 1ms		1 ms	
Insulation Re	Insulation Resistance		Minimum 1,000 M Ω (at 5		(at 500 VDC)	for insulation 4
Dielectric Strength		2,500 Vrms 1 minute			for input-output	
Operating Temperature Range		-30°C to + 85°C			no	
Storage Tem	Storage Temperature Range		-40°C to +100°C			frost
Case Color	Case Color Black			Red		
Weight	Weight		Approxima	ately 3.5 g	Approximately 2.9 g	

• OUTPUT MODULE High Speed Switching Type

ltem			AC Output module	Remarks
INPUT side	Nominal Voltage (DC)		5 V, 12 V, 24 V	
side	Operate Voltage Range		±20% of nominal voltage	
	Must Operate Voltage		80% of nominal voltage	
	Must Release V	oltage	Minimum 1 V	
	law the sade as	5 VDC Type	330 Ω ±10%	
	Input Impedance	12 VDC Type	1,0 k Ω ±10%	
		24 VDC Type	2,0 k Ω ±10%	
OUTPUT	Load Voltage		DC3 to 30V	
side	Maximum Load	Current	1.0 A	see CHARACTERISTIC DATA
	Minimum Load Current		1 mA	
	Switching Current		3 A (10 ms)	
	Max. Off-State Leakage Current		0.1 mA (at 30 VDC)	
	Max. On-State Voltage Drop		1.2 V	at max. load current
Maximum C	Maximum Operate Time		max. 5 µs	at DC 5 V 0.1A
Maximum F	Maximum Release Time		max. 25 µs	
Insulation Resistance			Minimum 1,000 M Ω (at 500 VDC)	for in and and and
Dielectric Strength			2,500 V rms 1 minute	for input-output
Operating Temperature Range		1	-40°C to + 100°C	
Storage Temperature Range			-30°C to + 85°C	
Case Color	Case Color		Red	
Weight	Weight		Approximately 2.9 g	

■ INSULATION

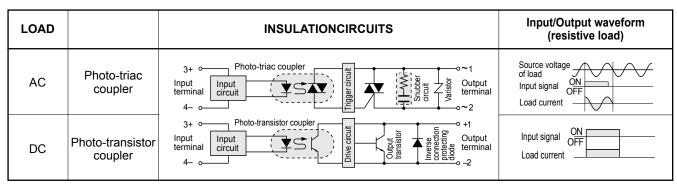
Item	Input module	Output module	Note
Resistance (initial)	Minimum 1,000 MΩ (500VDC)		Input-output
Surge Voltage	2,500V rms 1 min.		

■ BLOCK DIAGRAM

• INPUT MODULE

LOAD		INSULATION CIRCUITS	Input/Output waveform (resistive load)
DC Logic	Photo-transistor coupler	terminal 2(~) • Circuit • 5 GND • 5 GND	Input signal ON OFF Output signal "H" "L"
output	Photo-transistor coupler	Photo-transistor coupler Input terminal 2 (+/-) Suffer Circuit Suffer	Input signal ON OFF Output signal "H"

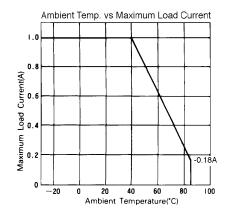
• OUTPUT MODULE



^{*} AC type without varistor / DC type with zenor diode available.

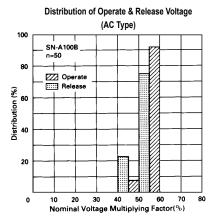
■ CHARACTERISTIC DATA

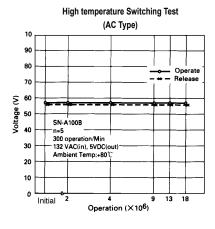
OUTPUT MODULE

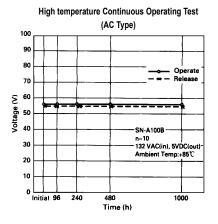


■ REFERENCE DATA

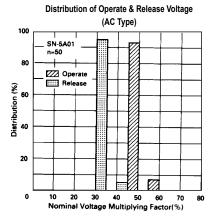
• INPUT MODULE

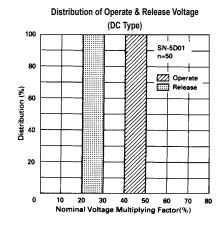


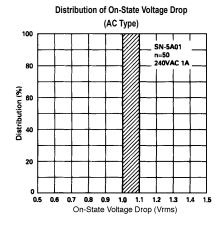




• OUTPUT MODULE



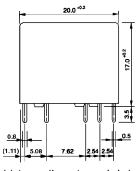




■ DIMENSIONS

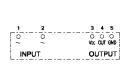
Dimensions

SN-A () type (input module)



0.3

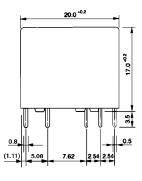
Schematics (BOTTOM VIEW)

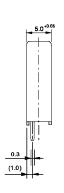


 PC board mounting hole layout (BOTTOM VIEW)



SN-D () type (input module)

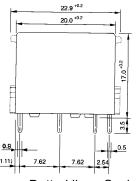


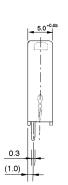


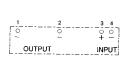
1 2 3 4 5
0 0 0 0
+/- +/- 1/- 1/- 1/- 0UTPUT
INPUT OUTPUT

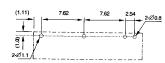


SN-A () type (output module)



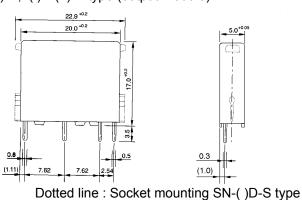




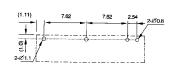


Dotted line: Socket mounting SN-()A-S type

SN-() D, ()D () R type (output module)





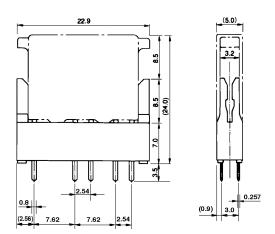


^{*} Reverse polarity type available

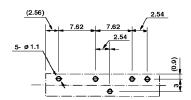
reverse polarity type available

Unit: mm

■ Socket Dimensions



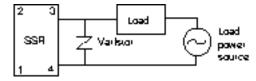
Socket PC board mounting hole layout



Unit: mm

■ NOTES

- 1. Polarity of terminals is pre-determined. Please design your circuit accordingly.
- 2. Socket ordering code: JL-5N
- 3. Standard IC socket is not recommended. Please use socket "JL-5N".
- 4. When switching inductive load by AC output module without varistor, please connect a varistor as shown in drawing below.
- 5. AC input module has inside logic IC. Please connect bypass condenser (approx. 0.01µ) at pivotal points between VDD and GND. (Conform to general handling instructions for logic IC.)



RoHS Compliance and Lead Free Relay Information

1. General Information

- Relays produced after the specific date code that is indicated on each data sheet are lead-free
 now. Most of our signal and power relays are lead-free. Please refer to Lead-Free Status Info.
 (http://www.fujitsu.com/us/downloads/MICRO/fcai/relays/lead-free-letter.pdf)
- Lead free solder paste currently used in relays is Sn-3.0Ag-0.5Cu.
- All signal and most power relays also comply with RoHS. Please refer to individual data sheets. Relays that are RoHS compliant do not contain the 5 hazardous materials that are restricted by RoHS directive (lead, mercury, chromium IV, PBB, PBDE).
- It has been verified that using lead-free relays in leaded assembly process will not cause any problems (compatible).
- "LF" is marked on each outer and inner carton. (No marking on individual relays).
- To avoid leaded relays (for lead-free sample, etc.) please consult with area sales office.
- We will ship leaded relays as long as the leaded relay inventory exists.

Note: Cadmium was exempted from RoHS on October 21, 2005. (Amendment to Directive 2002/95/EC)

2. Recommended Lead Free Solder Profile

Recommended solder paste Sn-3.0Ag-0.5Cu.

Reflow Solder condition

Flow Solder condition:

Pre-heating: maximum 120°C dip within 5 sec. at 260°C soler bath

Solder by Soldering Iron:

Soldering Iron

Temperature: maximum 360°C Duration: maximum 3 sec.

We highly recommend that you confirm your actual solder conditions

3. Moisture Sensitivity

Moisture Sensitivity Level standard is not applicable to electromechanical realys.

4. Tin Whisker

 Dipped SnAgCu solder is known as low risk tin whisker. No considerable length whisker was found by our in house test.

Fujitsu Components International Headquarter Offices

Japan

Fujitsu Component Limited Gotanda-Chuo Building 3-5, Higashigotanda 2-chome, Shinagawa-ku Tokyo 141, Japan Tel: (81-3) 5449-7010 Fax: (81-3) 5449-2626 Email: promothq@ft.ed.fujitsu.com Web: www.fcl.fujitsu.com

North and South America

Fujitsu Components America, Inc. 250 E. Caribbean Drive Sunnyvale, CA 94089 U.S.A. Tel: (1-408) 745-4900 Fax: (1-408) 745-4970

Email: components@us.fujitsu.com

Web: http://www.fujitsu.com/us/services/edevices/components/

Europe

Fujitsu Components Europe B.V. Diamantlaan 25 2132 WV Hoofddorp Netherlands Tel: (31-23) 5560910 Fax: (31-23) 5560950 Email: info@fceu.fujitsu.com Web: emea.fujitsu.com/components/

Asia Pacific

Fujitsu Components Asia Ltd. 102E Pasir Panjang Road #01-01 Citilink Warehouse Complex Singapore 118529 Tel: (65) 6375-8560 Fax: (65) 6273-3021

Fax: (65) 6273-3021 Email: fcal@fcal.fujitsu.com

Web: http://www.fujitsu.com/sg/services/micro/components/

©2008 Fujitsu Components America, Inc. All rights reserved. All trademarks or registered trademarks are the property of their respective owners.

Fujitsu Components America or its affiliates do not warrant that the content of datasheet is error free. In a continuing effort to improve our products Fujitsu Components America, Inc. or its affiliates reserve the right to change specifications/datasheets without prior notice. Rev. January 18, 2008.